

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6965053

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KISHORE KUMAR MUCHHERLA	10/29/2018
ASHUTOSH MALSHE	10/29/2018
VAMSI PAVAN RAYAPROLU	10/29/2018
SAMPATH K. RATNAM	10/29/2018
HARISH R. SINGIDI	10/29/2018
PETER FEELEY	10/29/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	MICRON TECHNOLOGY, INC.
<b>Street Address:</b>	8000 SOUTH FEDERAL WAY
<b>City:</b>	BOISE
<b>State/Country:</b>	IDAHO
<b>Postal Code:</b>	83716-9632
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17450653
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	smacdonald@lowenstein.com
<b>Correspondent Name:</b>	LOWENSTEIN SANDLER LLP
<b>Address Line 1:</b>	ONE LOWENSTEIN DRIVE
<b>Address Line 4:</b>	ROSELAND, NEW JERSEY 07068
<b>ATTORNEY DOCKET NUMBER:</b>	34300.1303 (L0076D)
<b>NAME OF SUBMITTER:</b>	PAUL M. KRUEGER, REG. 64,944
<b>SIGNATURE:</b>	/Paul M. Krueger/
<b>DATE SIGNED:</b>	10/12/2021
<b>Total Attachments: 7</b>	
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**ASSIGNMENT OF PATENT APPLICATION** Attorney Docket No.: 34300.76 (L0076)

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/we, the undersigned, Kishore Kumar Muchherla, Ashutosh Malshe, Vamsi Pavan Rayaprolu, Sampath K. Ratnam, Harish R. Singidi, and Peter Feeley, hereby sell, assign, and transfer to Micron Technology, Inc.

a corporation of Delaware  
(Type of Assignee: e.g., corporation, company, partnership, university, etc.)

having a principal place of business at 8000 South Federal Way, Boise, Idaho 83716-9632,

("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions or improvements that are disclosed in the application (provisional or non-provisional) for the United States patent which may have a declaration executed by the undersigned prior hereto or concurrently herewith and is entitled

**RELOCATING DATA TO LOW LATENCY MEMORY**

said patent application also identified as follows (when known):

[I/we hereby authorize an attorney or agent for said Assignee to insert below the application number and filing date of said patent application when known.]

United States Patent Application Number 16/175,605 filed October 30, 2018,

and in and to said application (provisional or non-provisional) and all provisional applications, non-provisional applications, utility applications, design applications, divisional applications, continuation applications, continued prosecution applications, continuation-in-part applications, substitute applications, renewal applications, reissue applications, reexaminations, extensions, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said inventions or improvements; and in and to all original patents, reissued patents, reexamination certificates, and extensions, that have been or shall be issued in the United States and all foreign countries on said inventions or improvements; and in and to all rights of priority resulting from the filing of said United States application and all rights to claim priority to said United States application;

agree that said Assignee may apply for and receive a patent or patents for said inventions or improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all provisional applications, non-provisional applications, utility applications, design applications, divisional applications, continuation applications, continued prosecution applications, continuation-in-part applications, substitute applications, renewal applications, reissue applications, reexaminations, extensions, and all other patent applications on any and all said inventions or improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and representatives all facts known to the undersigned relating to said inventions or improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or representatives in securing and maintaining proper patent protection for said inventions or improvements and for vesting title to said inventions or improvements, and all applications for patents and all patents on said inventions or improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

**Each Inventor: Please Sign and Date Below:**

<u>10/29/2018</u>	<u>Kishore Kumar Muchherla</u>
Date	Kishore Kumar Muchherla
<u>                    </u>	<u>Ashutosh Malshe</u>
Date	Ashutosh Malshe
<u>                    </u>	<u>Vamsi Pavan Rayaprolu</u>
Date	Vamsi Pavan Rayaprolu
<u>                    </u>	<u>Sampath K. Ratnam</u>
Date	Sampath K. Ratnam
<u>                    </u>	<u>Harish R. Singidi</u>
Date	Harish R. Singidi
<u>                    </u>	<u>Peter Feeley</u>
Date	Peter Feeley

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Date

\_\_\_\_\_  
Kishore Kumar Muchherla

10/29/2018  
Date

  
Ashutosh Malshe

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Date

\_\_\_\_\_  
Vamsi Pavan Rayaprolu

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Date

\_\_\_\_\_  
Sampath K. Ratnam

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Date

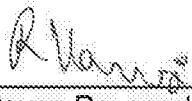
\_\_\_\_\_  
Harish R. Singidi

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Date

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**Each Inventor: Please Sign and Date Below:**

_____ Date	_____ Kishore Kumar Muchherla
_____ Date	_____ Ashutosh Malshe
10/29/2018 Date	 _____ Vamsi Pavan Rayaprolu
_____ Date	_____ Sampath K. Ratnam
_____ Date	_____ Harish R. Singidi
_____ Date	_____ Peter Feeley

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Ashutosh Malshe

\_\_\_\_\_  
Date

\_\_\_\_\_  
Vamsi Pavan Rayaprolu

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10/29/18

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Date

\_\_\_\_\_  
  
Sampath K. Ratnam

\_\_\_\_\_  
Date

\_\_\_\_\_  
Harish R. Singidi

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Date

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Date Vamsi Pavan Rayaprolu

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Date Sampath K. Ratnam

10/29/2018  
Date S. Harish Reddy  
Harish R. Singidi

\_\_\_\_\_  
Date Peter Feeley



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Date Sampath K. Ratnam

\_\_\_\_\_  
Date Harish R. Singidi

OCT 29, 2018  
Date   
Peter Feeley